CRMSP100N06A

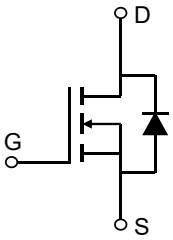
N-Channel 60V, 9.8mΩ Typ. Power MOSFET

Description

Features

- 60V, 100A

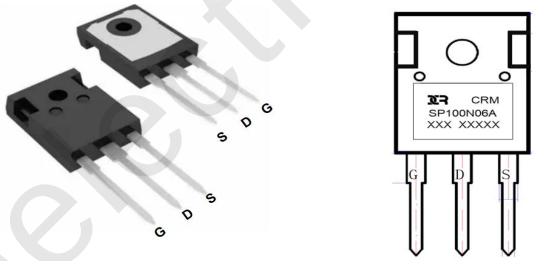
  $R_{DS(ON)}$ Typ = 9.8mΩ @ V_{GS} = 10V
- Fast Switching
- Improved dv/dt Capability
- 100% UIS TESTED!
- 100% ΔVds TESTED!



Schematic Diagram

Application

- Switch Mode Power Supply(SMPS)
- Uninterruptible Power Supply(UPS)
- Power Factor Correction(PFC)



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	TUBE(pcs)	Inner Box(pcs)	Per Carton (pcs)
CRMSP100N06A	CRMSP100N06A	TO-247-3L	TUBE	25	1000	2000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		60	V
V_{GS}	Gate-to-Source Voltage		±30	V
I_D	Continuous Drain Current	T_C = 25°C	100	A
		T_C = 100°C	60	A
I_{DM}	Pulsed Drain Current (1)		400	A
E_{AS}	Single Pulsed Avalanche Energy (2)		1764	mJ
P_D	Power Dissipation	T_C = 25°C	281	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.44	°C/W
T_J, T_{STG}	Junction & Storage Temperature Range		-55 to 150	°C

Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	I_D = 250μA, V_{GS} = 0V	60	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 60V, V_{GS} = 0V	-	-	1.0	μA
I_{GSS}	Gate-Body Leakage Current	V_{DS} = 0V, V_{GS} = ±30V	-	-	±100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250μA	0.7	1.6	2.5	V
$R_{DS(ON)}$	Static Drain-Source ON-Resistance(3)	V_{GS} = 10V, I_D = 30A	-	9.8	12.8	mΩ
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{GS} = 0V, V_{DS} = 25V, f = 1MHz	-	5518	-	pF
C_{oss}	Output Capacitance		-	1517	-	pF
C_{rss}	Reverse Transfer Capacitance		-	145	-	pF
Q_g	Total Gate Charge	V_{GS} = 0 to 10V V_{DS} = 30V, I_D = 50A	-	125	-	nC
Q_{gs}	Gate Source Charge		-	20	-	nC
Q_{gd}	Gate Drain("Miller") Charge		-	36	-	nC
Switching Characteristics						
$t_{d(on)}$	Turn-On DelayTime	V_{GS} = 10V, V_{DD} = 30V I_D= 50A, R_{GEN} = 2.7Ω	-	18	-	ns
t_r	Turn-On Rise Time		-	100	-	ns
$t_{d(off)}$	Turn-Off DelayTime		-	88	-	ns
t_f	Turn-Off Fall Time		-	44	-	ns
Drain-Source Diode Characteristics and Max Ratings						
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	100	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	400	A
V_{SD}	Drain to Source Diode Forward Voltage	V_{GS} = 0V, I_S = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	I_F = 50A, di/dt = 100A/us	-	67	-	ns
Qrr	Body Diode Reverse Recovery Charge		-	132	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. E_{AS} condition: Starting T_J=25°C, V_{DD}=30V, V_G=10V, R_G=25ohm, L=0.5mH, I_{AS}=84A

4. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%.

Test Circuit

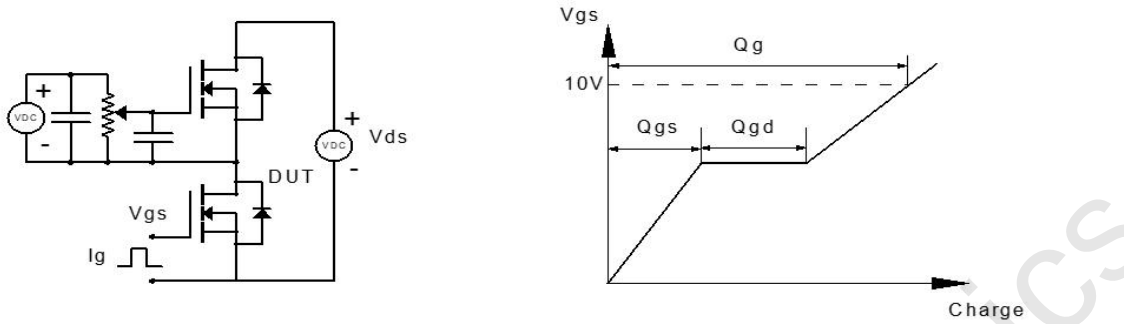


Figure 1: Gate Charge Test Circuit & Waveform

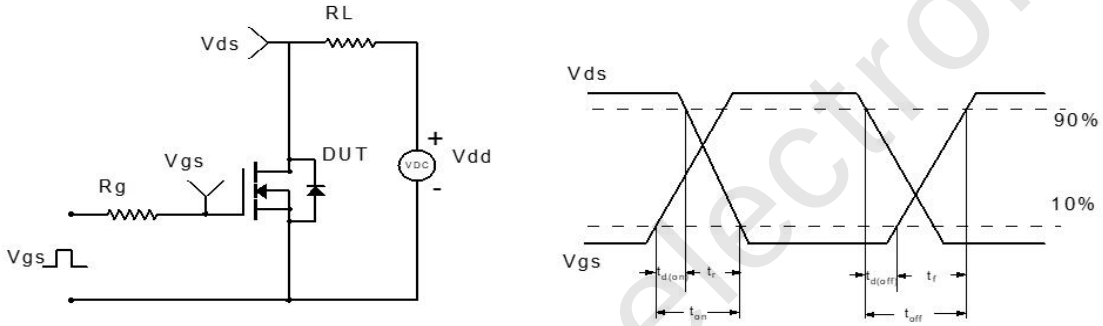


Figure 2: Resistive Switching Test Circuit & Waveform

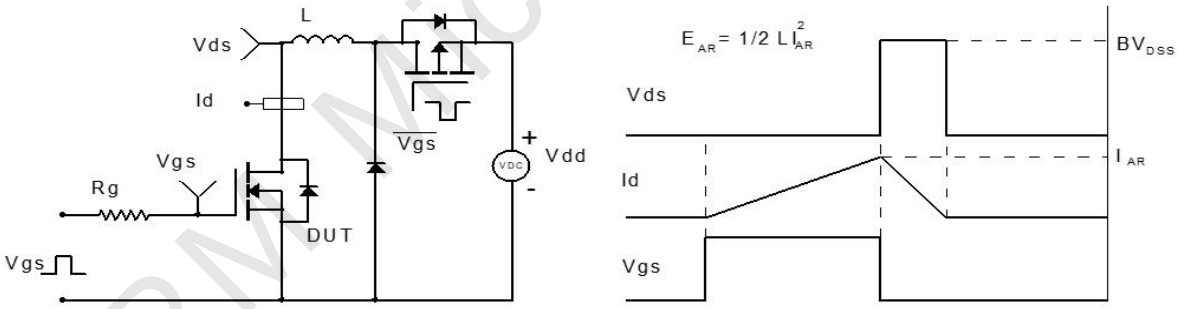


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

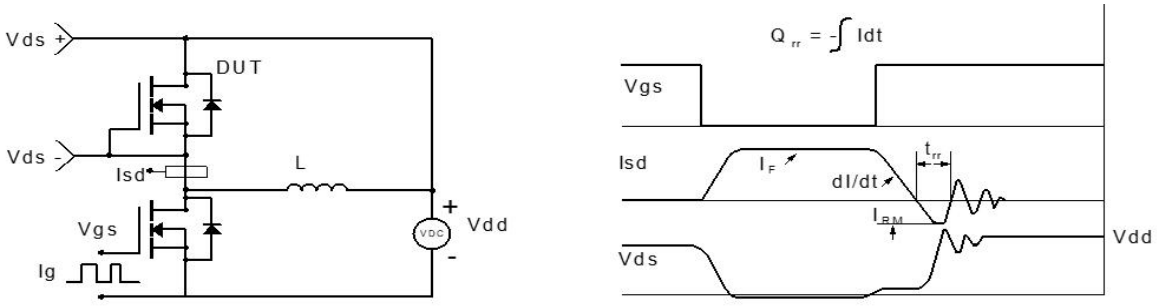
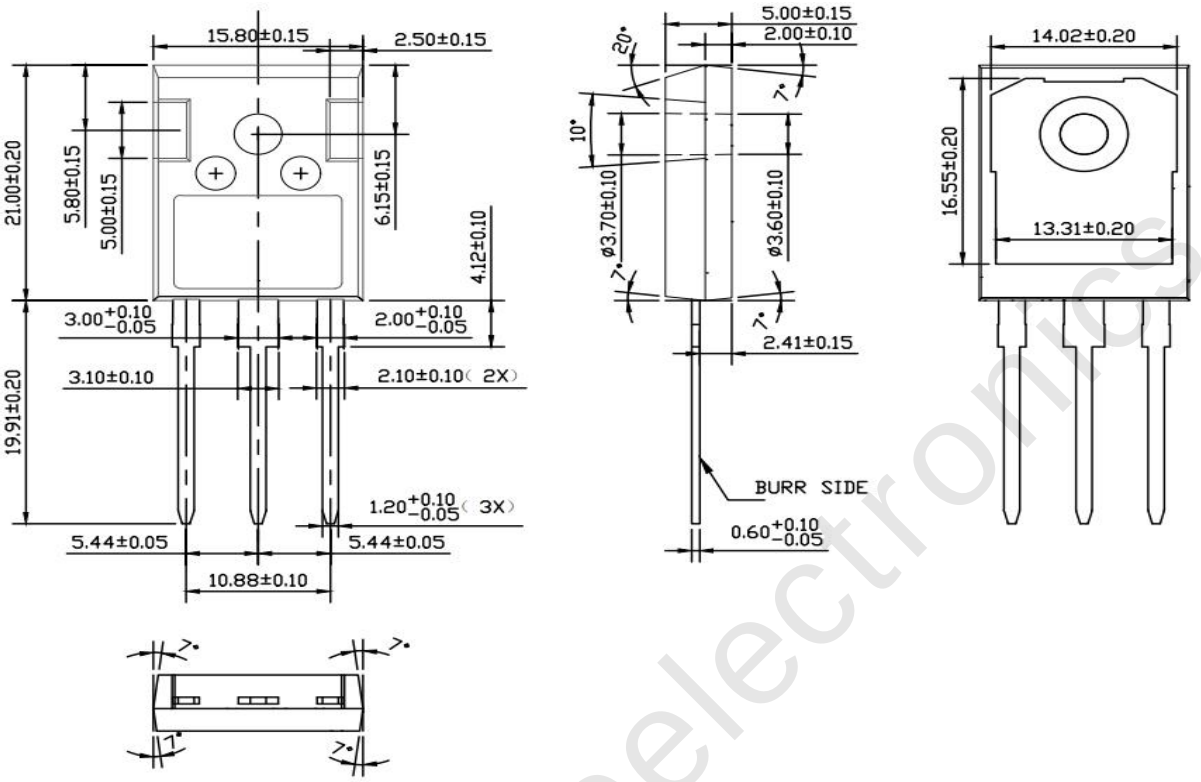


Figure 4: Diode Recovery Test Circuit & Waveform

Package Mechanical Data(TO-247-3L)



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